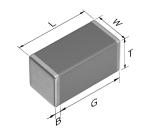
## 积层贴片陶瓷片式电容器

## C3216CH1H223K060AA

RoHS Reach Halogen Free Pb Free

交货型号	C3216CH1H223KT****
用途	一般等级
特点	General 一般(~75V)
系列	C3216 [EIA 1206]
状态	▲ 量产体制(新设计非推荐)



尺寸		
长度(L)	3. 20mm ±0. 20mm	
宽度(W)	1.60mm ±0.20mm	
厚度(T)	$0.60$ mm $\pm 0.15$ mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	1.00mm Min.	
推荐焊盘布局(PA)	2.10mm to 2.50mm(Flow Soldering)	
1世存/产益41/月(1五)	2.00mm to 2.40mm(Reflow Soldering)	
推荐焊盘布局(PB)	1.10mm to 1.30mm(Flow Soldering)	
进行/产益和/内(LD)	1.00mm to 1.20mm(Reflow Soldering)	
推荐焊盘布局(PC)	1.00mm to 1.30mm(Flow Soldering)	
3世行/平価/11/13 (1 し)	1.10mm to 1.60mm(Reflow Soldering)	

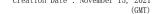
电气特性	
电容	$22 nF \pm 10\%$
额定电压	50VDC
温度特性	CH(0±60ppm/° C)
Q (Min.)	1000
绝缘电阻 (Min.)	10000MΩ

	其他
焊接方法	流体
<b>年按月</b> 伍	回流
AEC-Q200	NO NO
包装形式	纸编带 (180mm卷筒)
包装个数	4000pcs

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.



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特性图表(这是参考数据,并不保证产品的特性。)

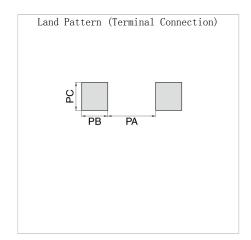
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## Associated Images



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